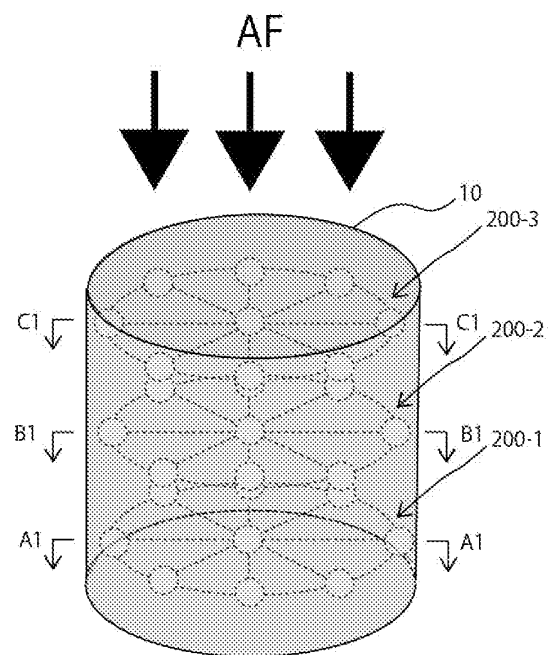
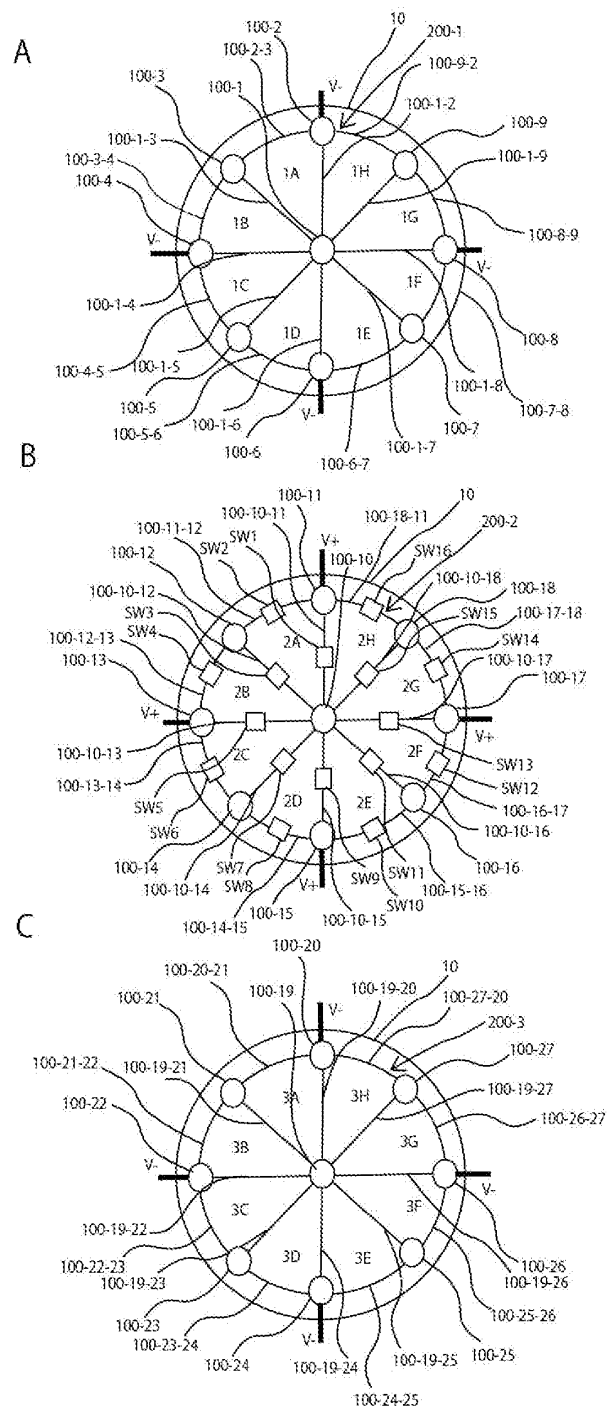


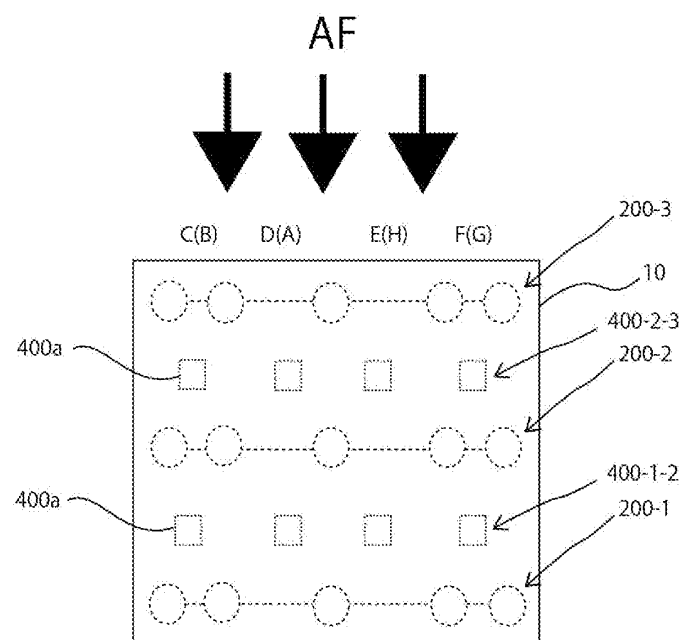
[図1]



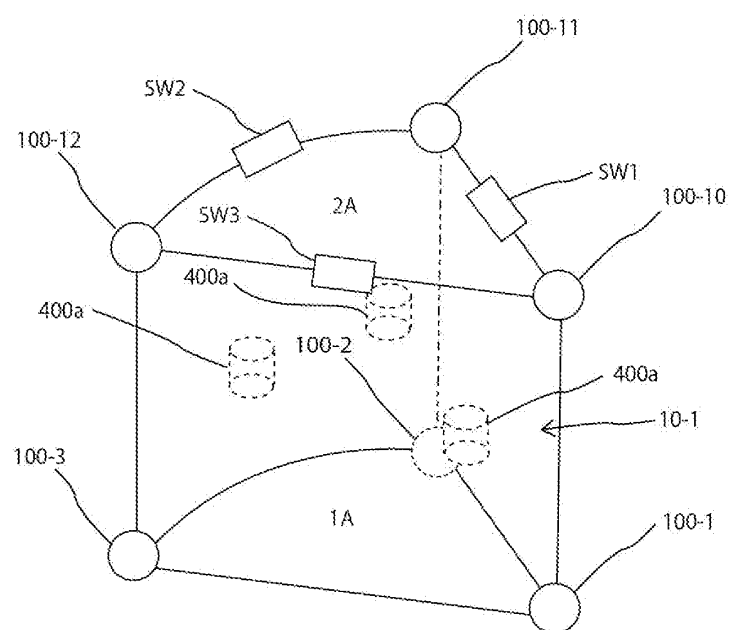
[図2]



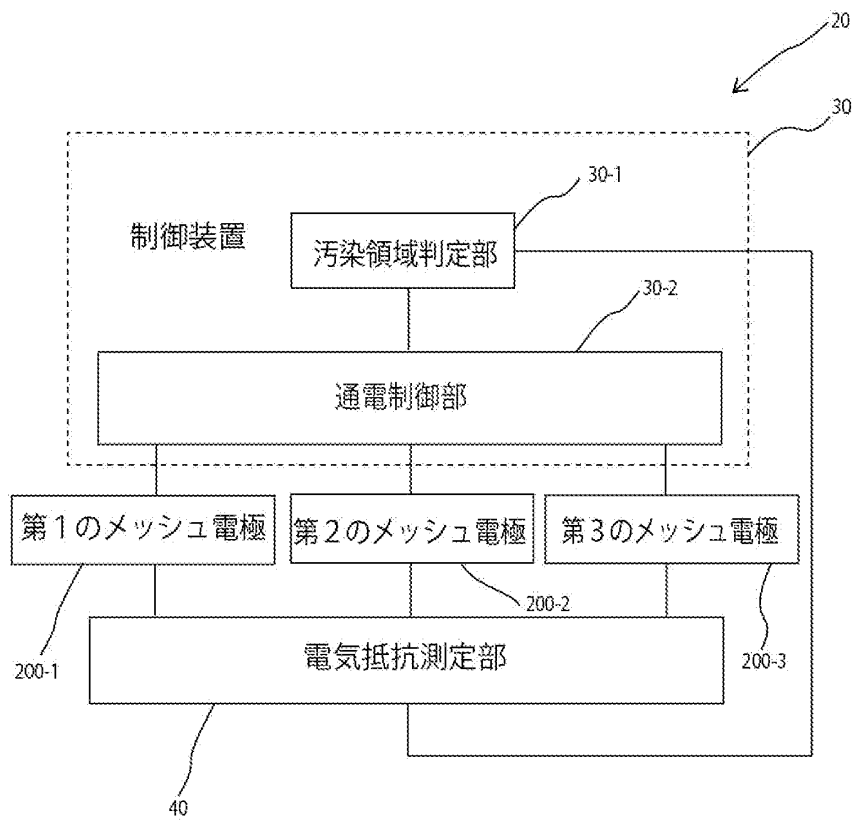
[図3]



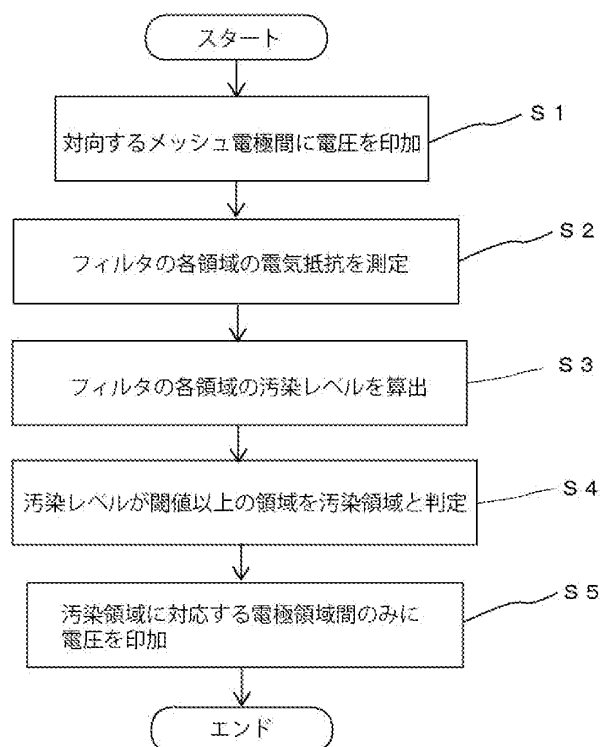
[図4]



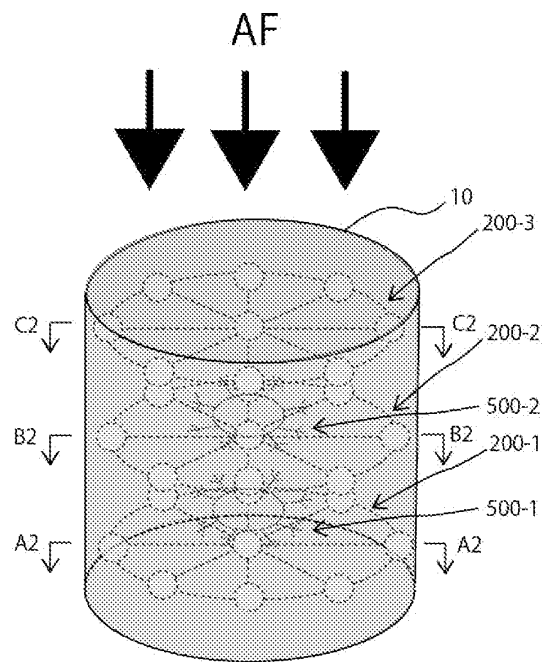
[図5]



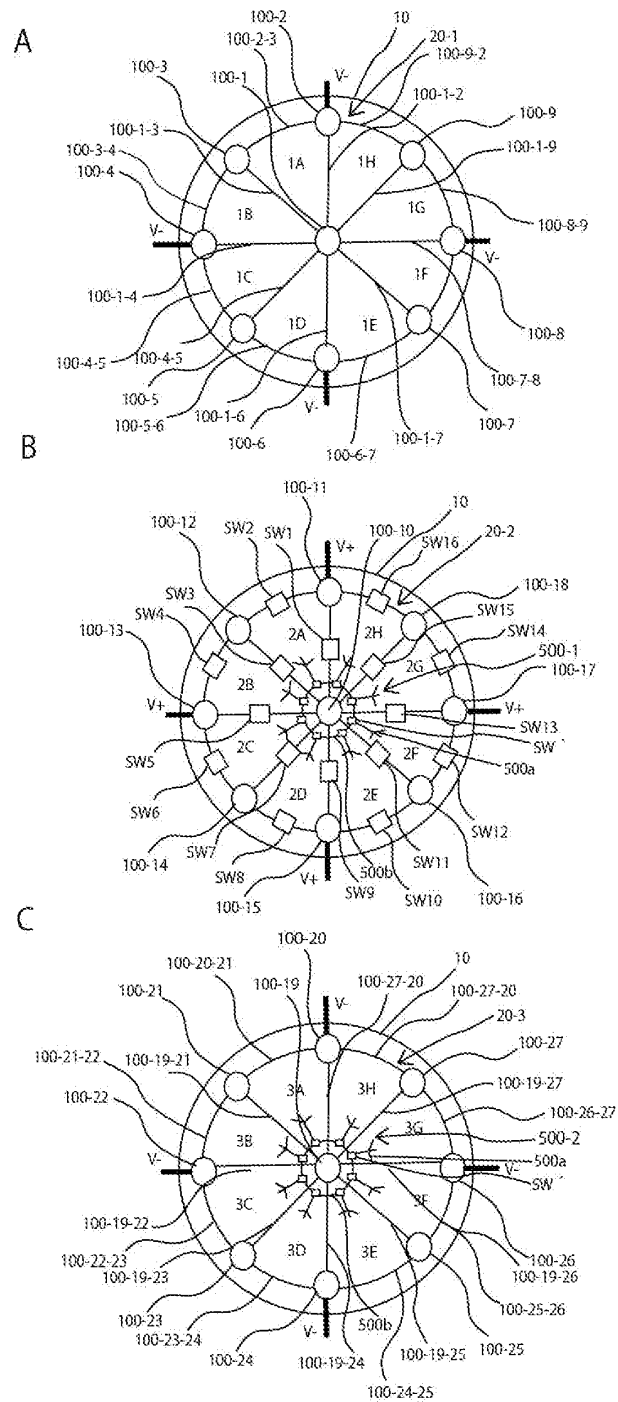
[図6]



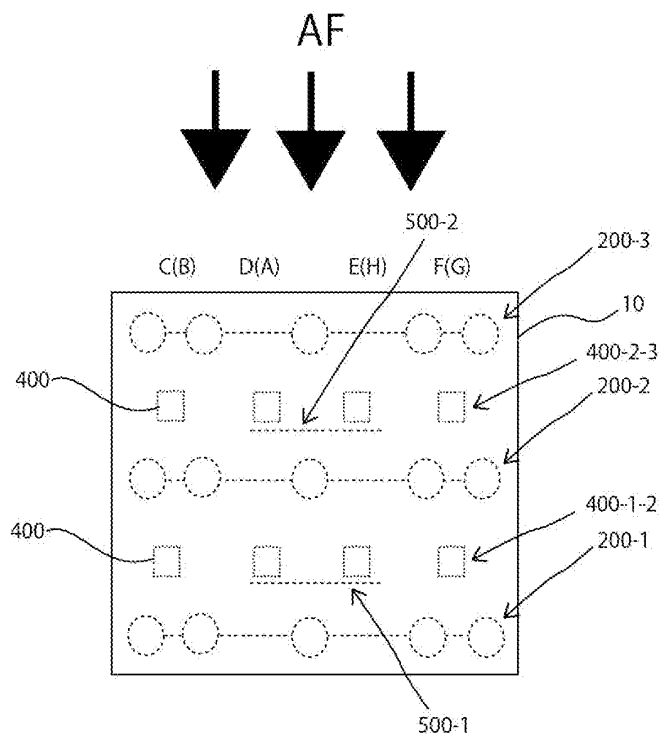
[図7]



[図8]

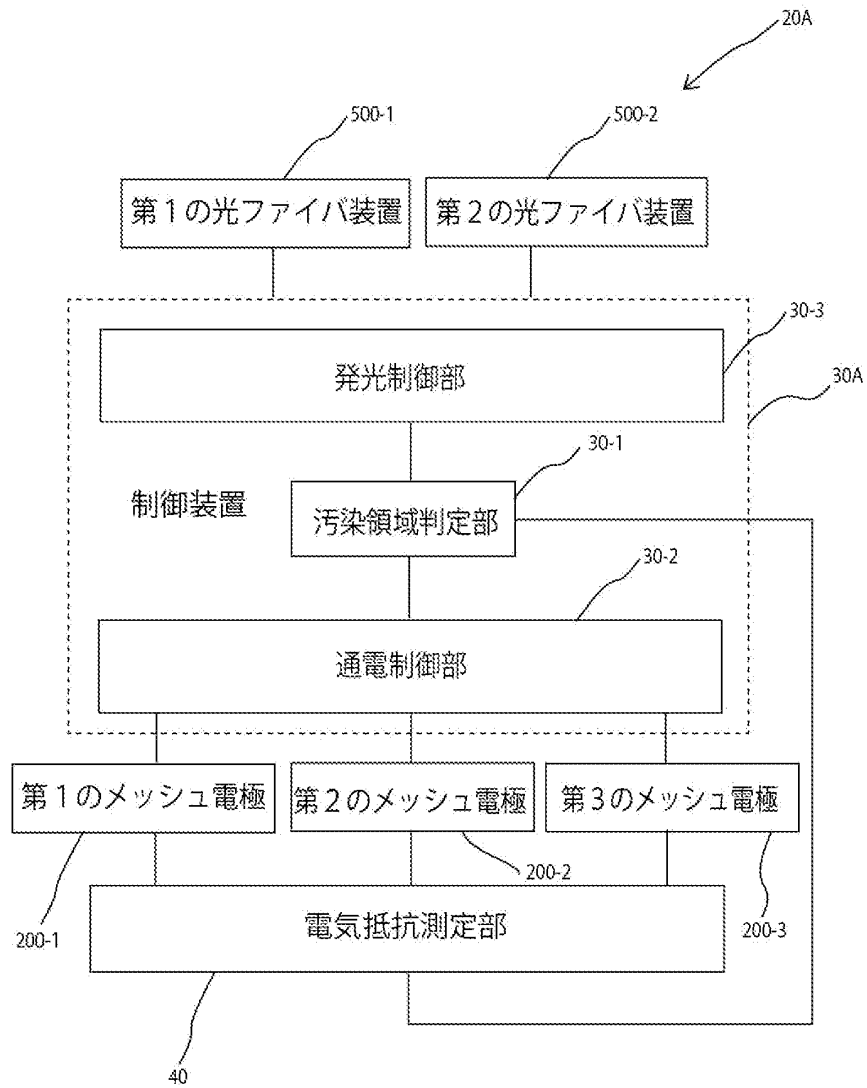


[図9]

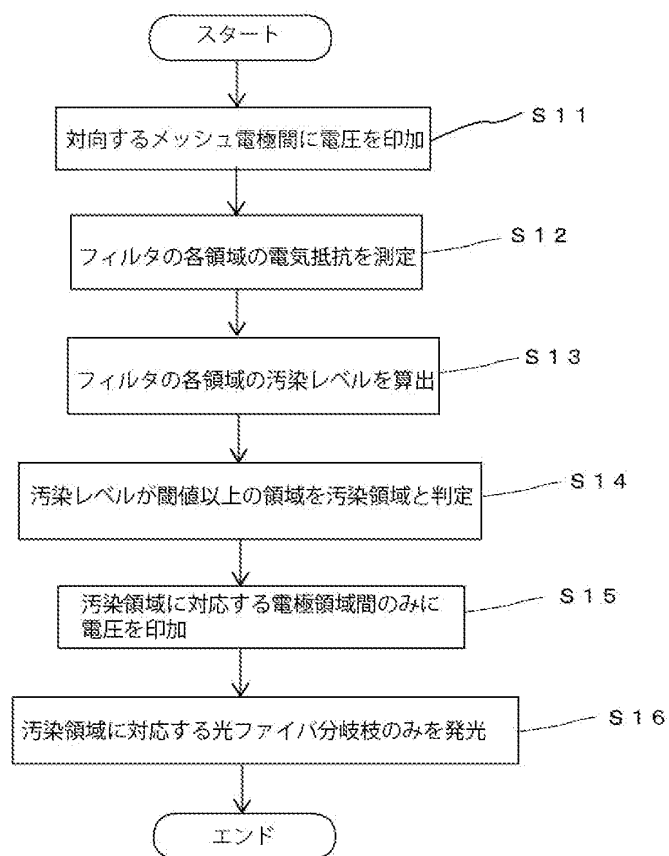




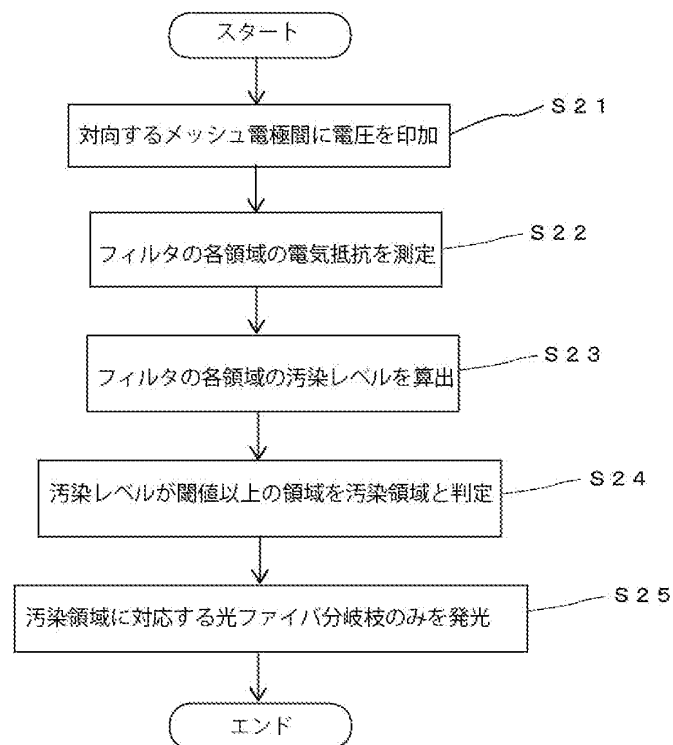
[図11]



[図12]

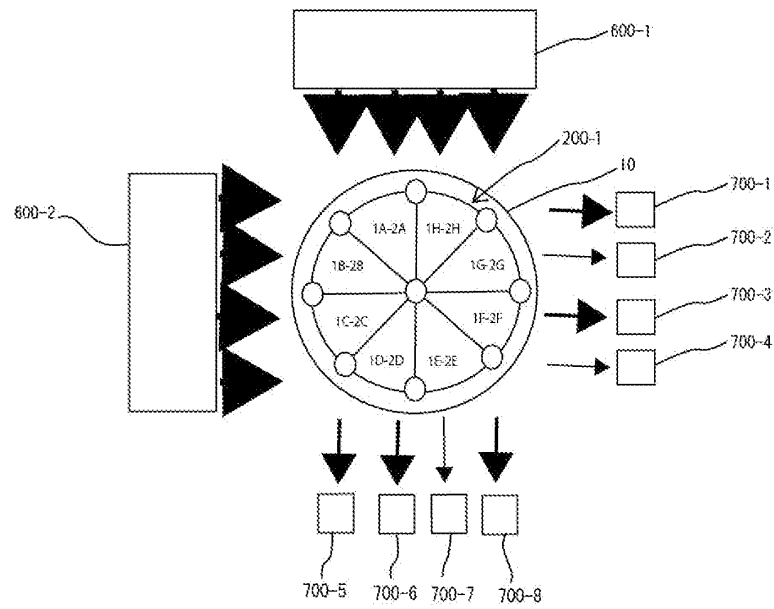


[図13]



[図14]

A



B

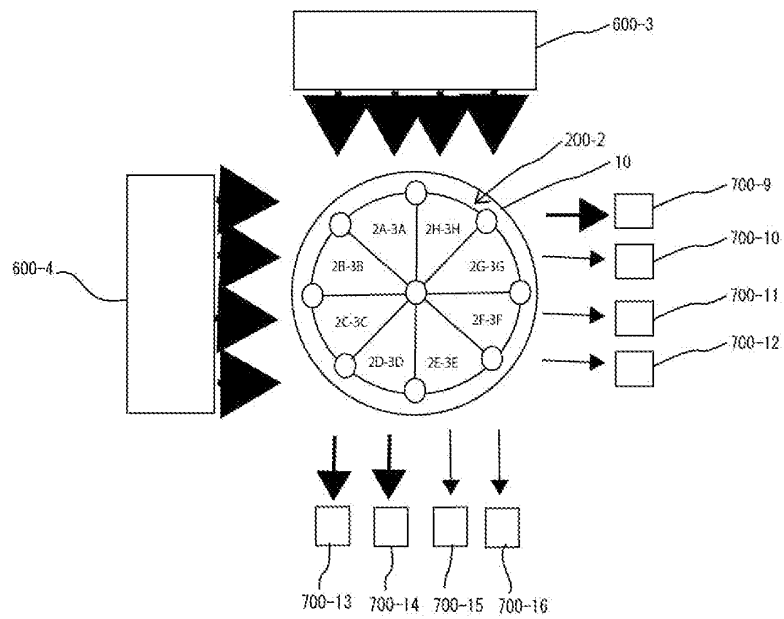




Figure 1 consists of two plan views, (A) and (B), of a circular substrate 10. Both views show the substrate divided into eight segments by dashed lines, with vias at the segment boundaries and center. In view (A), the segments are labeled 1A through 1H, and the vias are labeled V+. In view (B), the segments are labeled 3A through 3H, and the vias are labeled V-. The segments are shaded in different patterns: 1A and 3A are dark gray, 1B and 3B are light gray, 1C and 3C are medium gray, 1D and 3D are white, 1E and 3E are light gray, 1F and 3F are medium gray, 1G and 3G are light gray, and 1H and 3H are dark gray. The vias are labeled V+ in (A) and V- in (B). The segments are labeled 100-1 through 100-8 in (A) and 100-19 through 100-26 in (B). The vias are labeled 100-2 through 100-9 in (A) and 100-20 through 100-27 in (B). The segments are labeled 10A through 10G in (A) and 10B through 10G in (B). The vias are labeled 200-1 through 200-8 in (A) and 200-3 through 200-8 in (B).